

# 100V N-Channel MOSFETs

## SOT-223 Pin Configuration

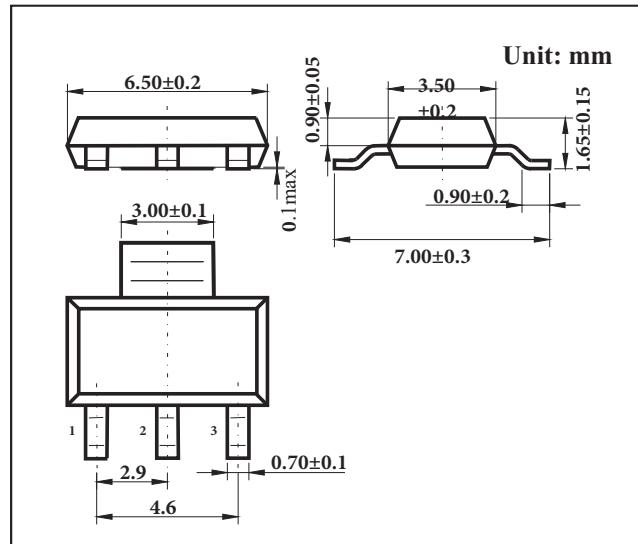
BVDSS	RDS(ON)	ID
100V	185mΩ	3A

### Features

- 100V, 3A,  $R_{DS(ON)} = 185\text{m}\Omega$  @  $V_{GS} = 10\text{V}$
- Improved  $dv/dt$  capability
- Fast switching
- 100% EAS Guaranteed

### Applications

- Networking
- Load Switch
- LED applications



## MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	$V_{DS}$	100	V
Gate-Source Voltage	$V_{GS}$	+20	V
Drain Current – Continuous ( $T_c=25\text{C}$ )	$I_D$	3	A
Drain Current – Continuous ( $T_c=100\text{C}$ )		1.8	A
Drain Current – Pulsed <sup>1</sup>	$I_{DM}$	12	A
Power Dissipation ( $T_c=25\text{C}$ )	$P_D$	1.78	W
Power Dissipation – Derate above 25C		0.014	W/°C
Storage Temperature Range	$T_{STG}$	-50 to 150	°C
Operating Junction Temperature Range	$T_J$	-50 to 150	°C

### Thermal Characteristics

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to ambient	$R_{8JA}$	---	70	°C/W
Thermal Resistance Junction to case	$R_{8JC}$		30	°C/W

**MOSFET ELECTRICAL CHARACTERISTICS**  $T_A = 25^\circ C$  unless otherwise specified

**Off Characteristics**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	100	---	---	V
$\beta BV_{DSS}/\beta T_J$		Reference to $25^\circ C, I_D=1mA$	---	0.10	---	$V/^\circ C$
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=100V, V_{GS}=0V, T_J=25^\circ C$	---	---	1	$\mu A$
		$V_{DS}=80V, V_{GS}=0V, T_J=125^\circ C$	---	---	10	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=+20V, V_{DS}=0V$	---	---	+100	nA

**On Characteristics**

Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=2A$	---	160	185	$m\Omega$
		$V_{GS}=4.5V, I_D=1A$	---	170	195	$m\Omega$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.2	1.8	2.5	V
$\beta V_{GS(th)}$			---	-4	---	$mV/^\circ C$
Forward Transconductance	$g_{fs}$	$V_{DS}=10V, I_D=1A$	---	5	---	S

**Dynamic and switching Characteristics**

Total Gate Charge <sup>2,3</sup>	$Q_g$	$V_{DS}=50V, V_{GS}=10V, I_D=2A$	---	13.4	21	nC
Gate-Source Charge <sup>2,3</sup>	$Q_{gs}$		---	2.9	6	
Gate-Drain Charge <sup>2,3</sup>	$Q_{gd}$		---	1.7	4	
Turn-On Delay Time <sup>2,3</sup>	$T_{d(on)}$	$V_{DD}=30V, V_{GS}=10V, R_G=3.3\Omega$	---	1.6	3	ns
Rise Time <sup>2,3</sup>	$T_r$		---	6.6	13	
Turn-Off Delay Time <sup>2,3</sup>	$T_{d(off)}$		---	11.5	22	
Fall Time <sup>2,3</sup>	$T_f$		---	3.6	7	
Input Capacitance	$C_{iss}$		---	820	1190	pF
Output Capacitance	$C_{oss}$	$V_{DS}=50V, V_{GS}=0V, F=1MHz$	---	35	55	
Reverse Transfer Capacitance	$C_{rss}$		---	20	30	
Gate resistance	$R_g$	$V_{GS}=0V, V_{DS}=0V, F=1MHz$	---	1.3	2.6	$\Omega$

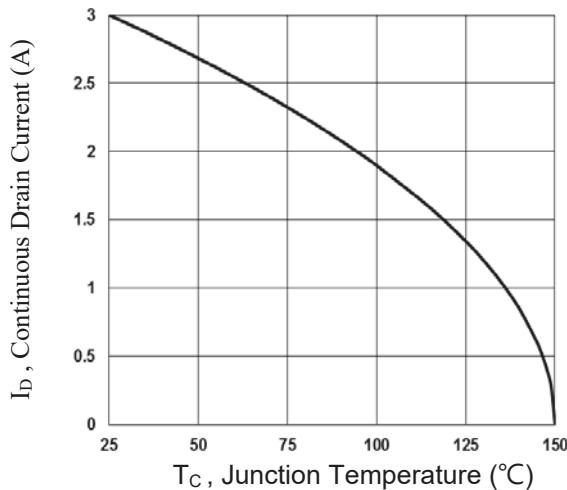
**Drain-Source Diode Characteristics and Maximum Ratings**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	$I_s$	$V_G=V_D=0V$ , Force Current	---	---	3	A
Pulsed Source Current	$I_{SM}$		---	---	6	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_s=1A, T_J=25^\circ C$	---	---	1	V

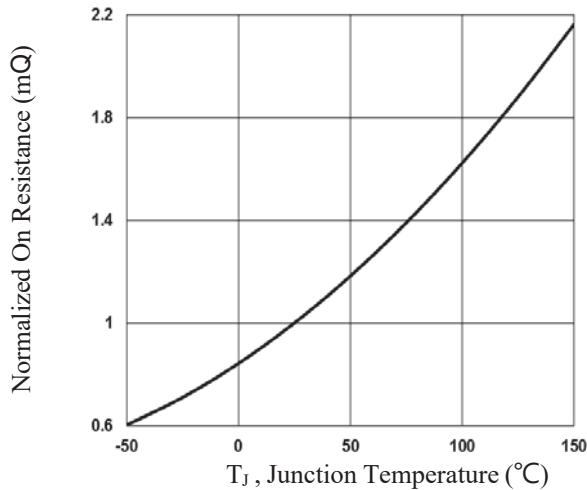
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.

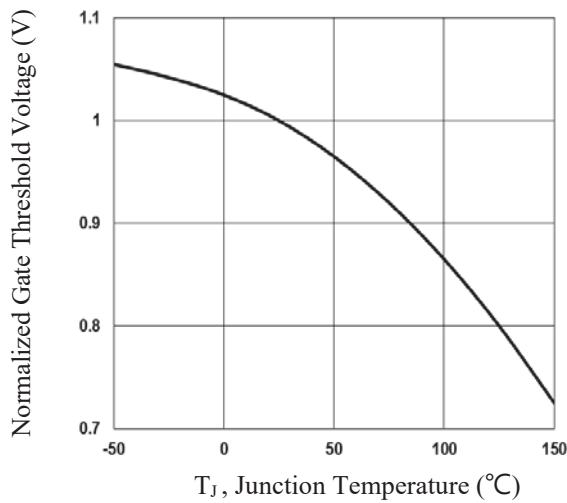
## RATINGS AND CHARACTERISTIC CURVES



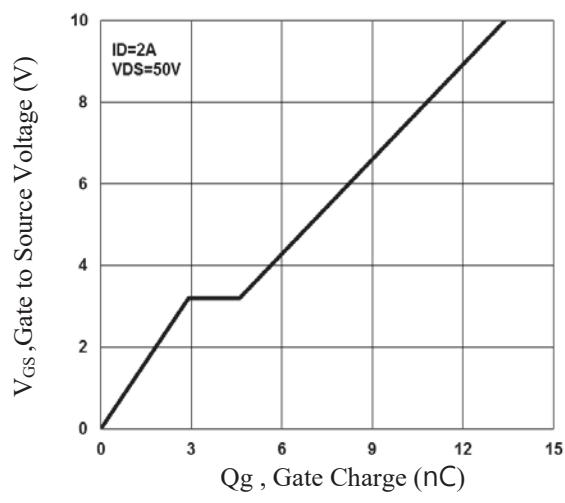
**Fig.1 Continuous Drain Current vs. T<sub>c</sub>**



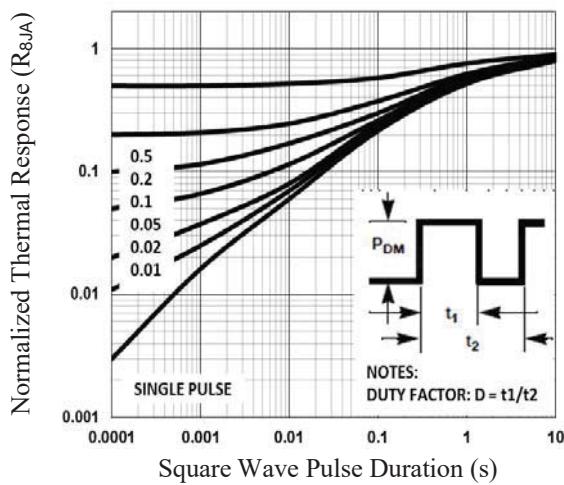
**Fig.2 Normalized RDSON vs. T<sub>J</sub>**



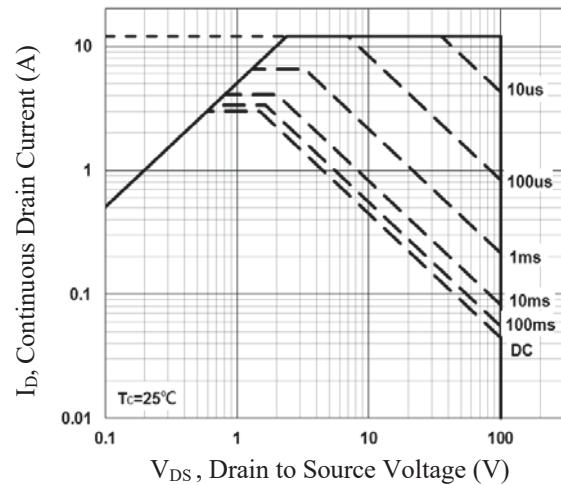
**Fig.3 Normalized V<sub>th</sub> vs. T<sub>J</sub>**



**Fig.4 Gate Charge Waveform**

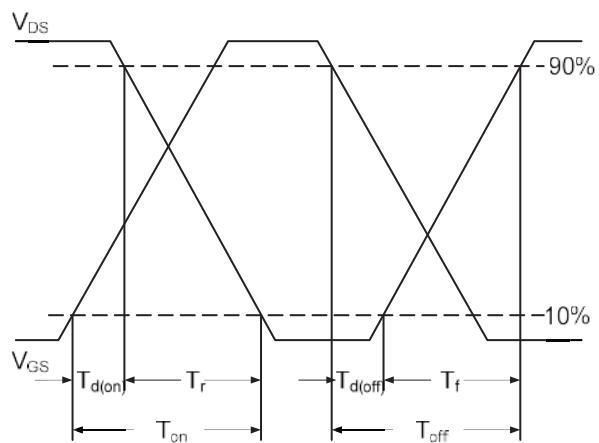


**Fig.5 Normalized Transient Impedance**

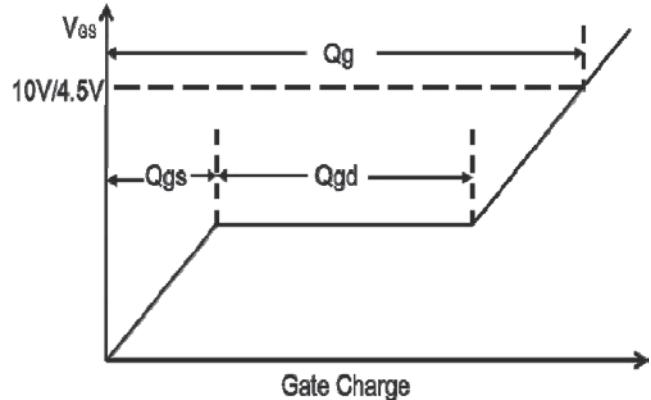


**Fig.6 Maximum Safe Operation Area**

## RATINGS AND CHARACTERISTIC CURVES



**Fig.7** Switching Time Waveform



**Fig.8** Gate Charge Waveform